

D

D

C

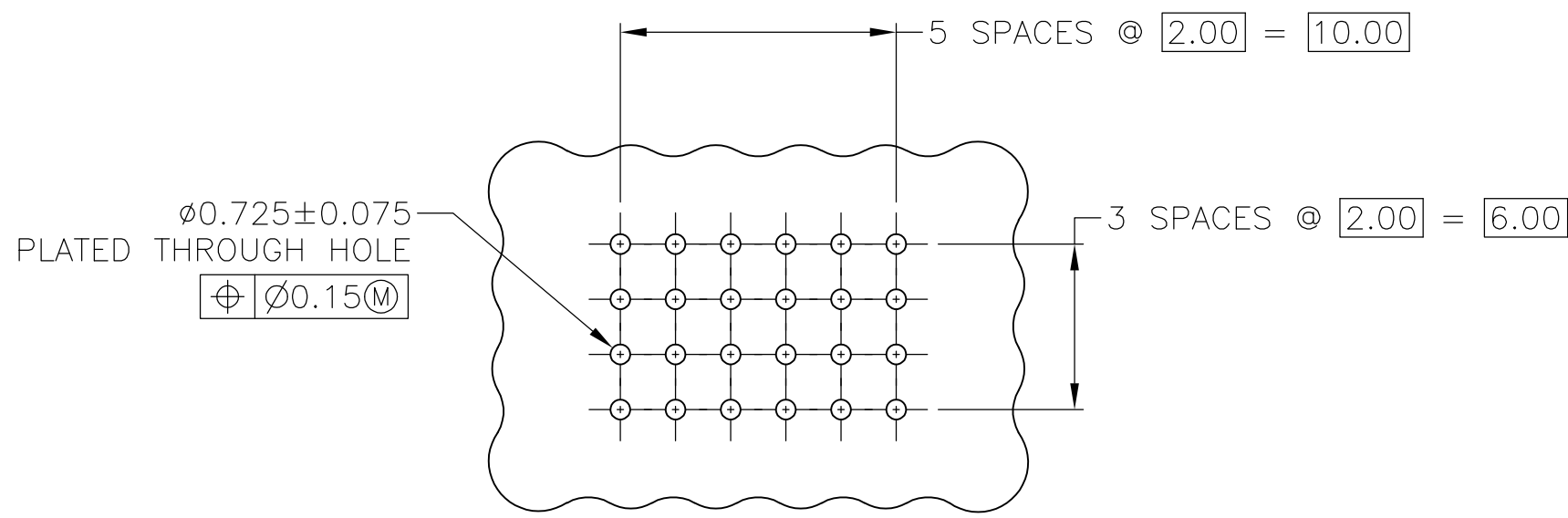
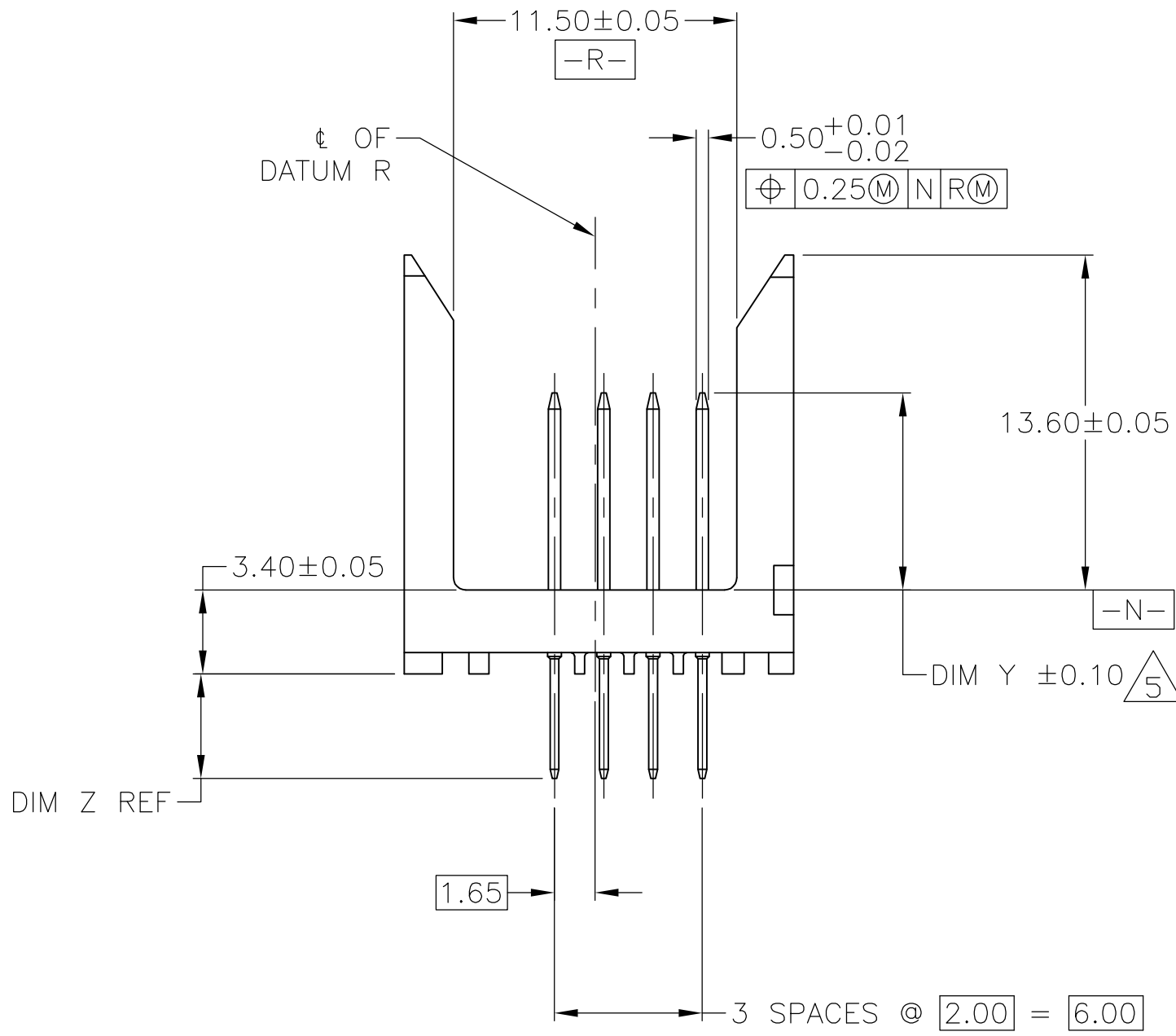
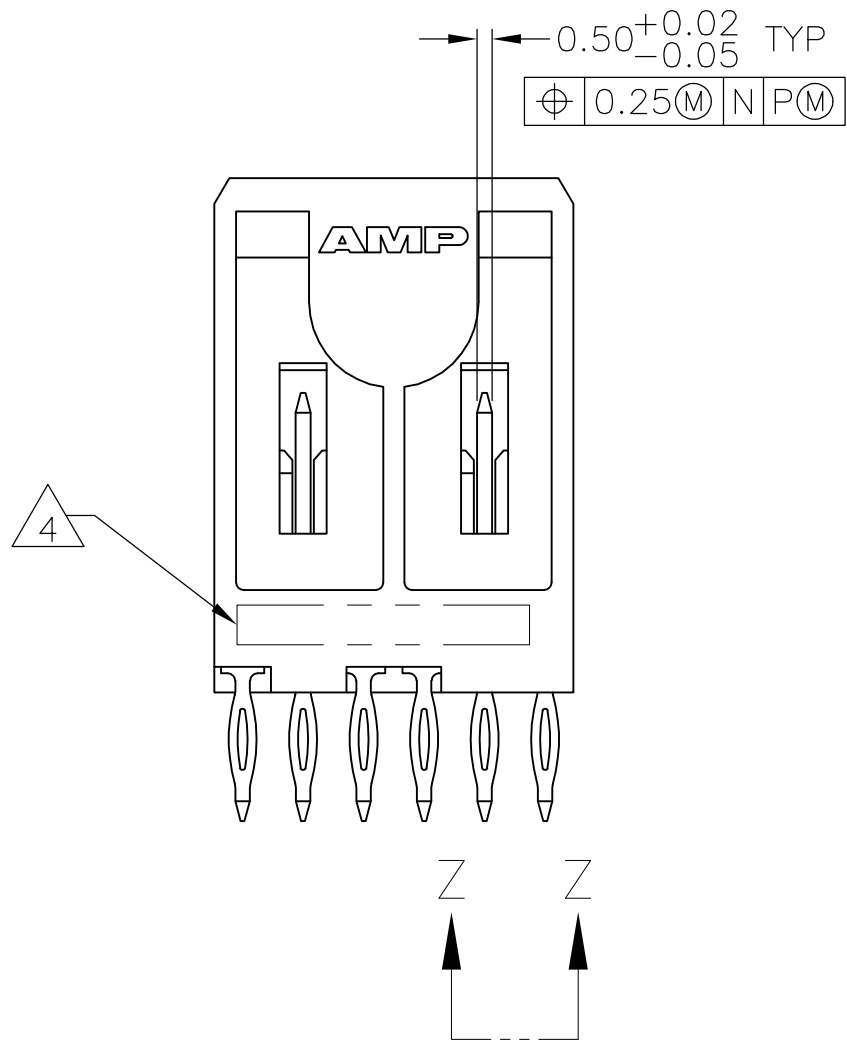
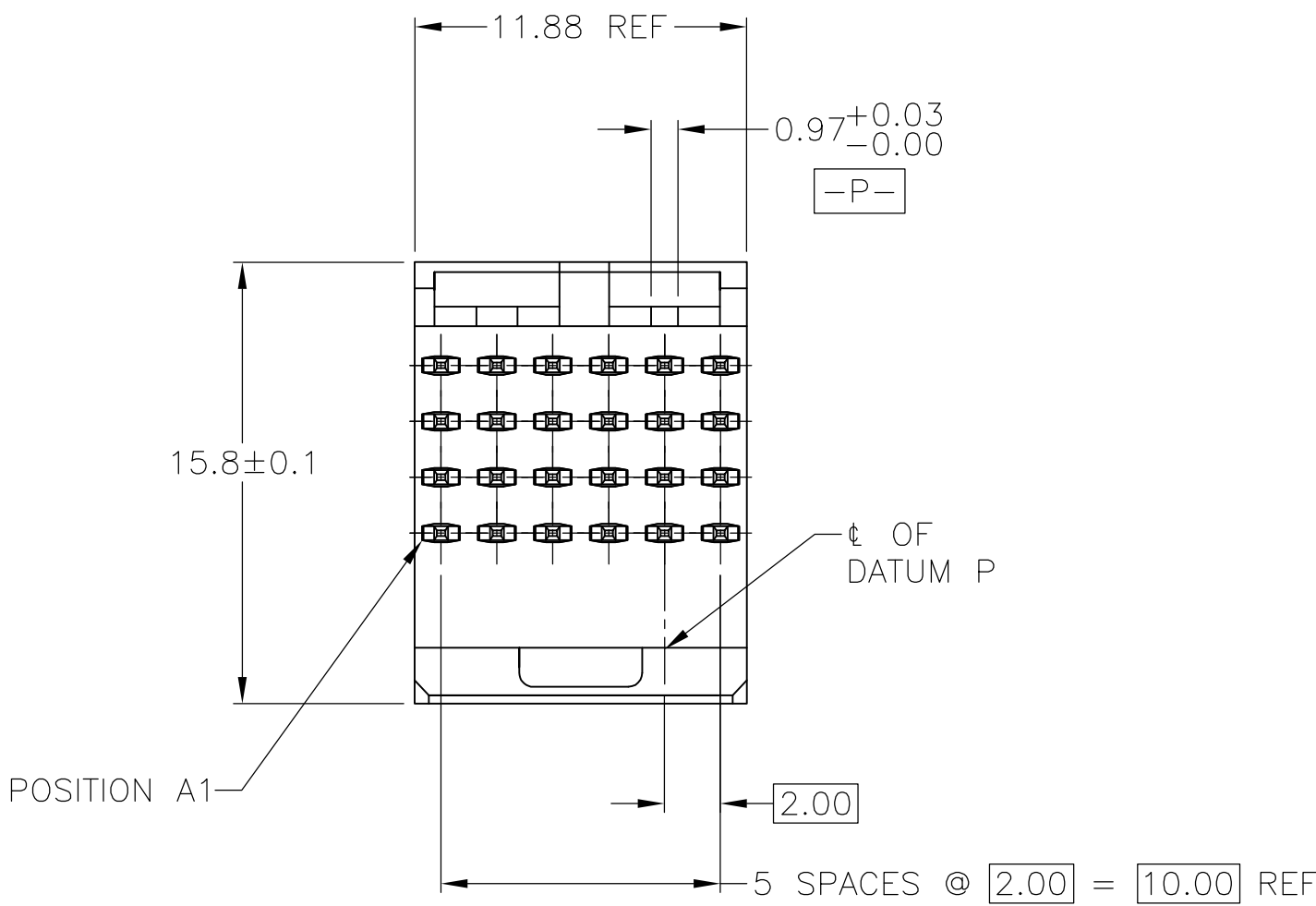
C

B

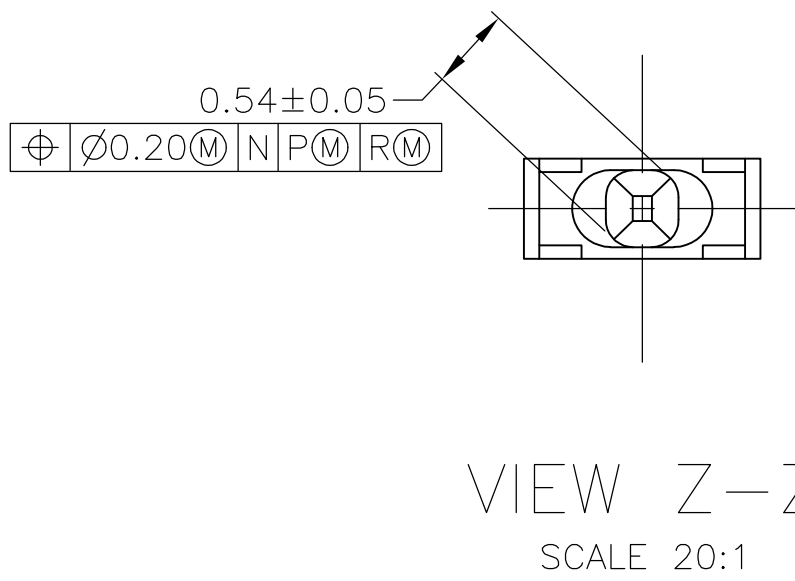
B

A

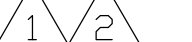
A



RECOMMENDED CIRCUIT PATTERN
PER IPC-D300 TYPE II, CLASS C
(COMPONENT SIDE)



- 1 HOUSING MATERIAL: LIQUID CRYSTAL POLYMER, NATURAL.
- 2 CONTACT MATERIAL: PHOSPHOR BRONZE.
- 3 CONTACT FINISH:(B)
UNDERPLATE (ENTIRE CONTACT):
0.00127 MIN NICKEL PER SAE-AMS-QQ-N-290
ON MATING SURFACES:
CONFORMS TO ALL TESTING SPECIFIED FOR TELCORDIA
UNCONTROLLED ENVIRONMENT.
ON LEADS:
0.0006 MIN MATTE TIN PER ASTM B 545 OVER UNDERPLATE.
LUBRICATION (MIN MATING SURFACES):
SURFACE CONDITIONER AFTER PLATING.
- 4 PART MARKING, LOCATED APPROXIMATELY AS SHOWN.
- 5 DIMENSION APPLIES WHEN SEATED ON PRINTED CIRCUIT BOARD.

THIS DRAWING IS A CONTROLLED DOCUMENT.				DWN B.MCMMASTER CHK R.WERTZ APP'D R.WERTZ	15DEC04 15DEC04 15DEC04	tyco Electronics		Tyco Electronics Corporation Harrisburg, Pa 17105-3608	
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME		PIN ASSY, SIGNAL MODULE, Z-PACK 2mm FB, 4 ROW, 24 POSN, PRESS FIT LEADS WITH VARIOUS LEVELS OF SEQUENCING			
		0 PLC	± -	PRODUCT SPEC		SIZE A1			
		1 PLC	± -	108-1441					
		2 PLC	± 0.13	APPLICATION SPEC					
		3 PLC	± -	114-1075					
		4 PLC	± -	WEIGHT					
MATERIAL		FINISH		CUSTOMER DRAWING		SCALE		SHEET	
				4:1		1		2 OF 2	
						REV		B	

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